**Key Features** 



### **DATA COMMUNICATIONS**

# 9-Line Plug and Play **SCSI Terminator**

The 9-channel IMP5218 SCSI terminator is part of IMP's family of highperformance SCSI terminators that deliver true UltraSCSI performance. The BiCMOS design offers superior performance over first generation linear regulator/resistor based terminators.

The IMP5218 has two disconnect pins for SCSI Plug and Play (PnP) applications.

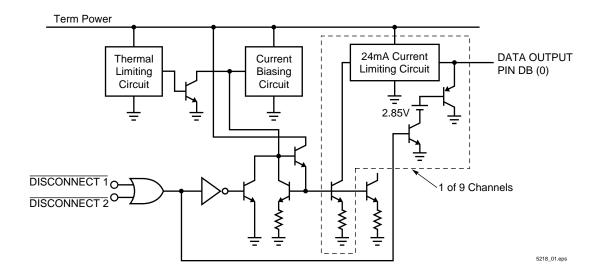
IMP's new architecture employs high-speed adaptive elements for each channel, thereby providing the fastest response possible - typically 35MHz, which is 100 times faster than the older linear regulator terminator approach. The bandwidth of terminators based on the older regulator/resistor terminator architecture is limited to 500kHz since a large output stabilization capacitor is required. The IMP architecture eliminates the external output compensation capacitor and the need for transient output capacitors while maintaining pin compatibility with first generation designs. Reduced component count is inherent with the IMP5218.

The IMP5218 architecture tolerates marginal system designs. A key improvement offered by the IMP5218 lies in its ability to insure reliable, error-free communications even in systems which do not adhere to recommended SCSI hardware design guidelines, such as improper cable lengths and impedance. Frequently, this situation is not controlled by the peripheral or host designer.

For portable and configurable peripherals, the IMP5218 can be placed in a sleep mode with two disconnect signals. When disabled, the quiescent current is typically 375µA, and the outputs are in a high impedance state.

- SCSI plug and play
  - Dual disconnect pins
  - Logic LOW disconnects lines
- Hot swap compatible
- Ultra-Fast response for Fast-20 SCSI applications
- 35MHz channel bandwidth
- 3.5V operation
- Less than 3pF output capacitance
- 375µA disable-mode current
- Thermally self limiting
- No external compensation capacitors
- Implements 8-bit or 16-bit (wide) applications
- Compatible with active negation drivers (60mA/channel)
- **♦** Compatible with passive and active terminations
- ◆ Approved for use with SCSI 1, 2, 3 and UltraSCSI

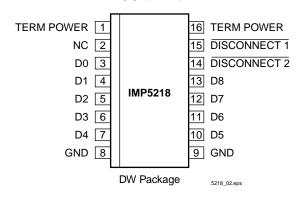
# **Block Diagrams**



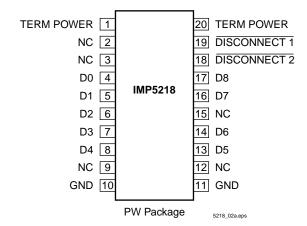


### Pin Configuration

#### SOWB-16



#### TSSOP-20



# **Ordering Information**

Part Number	Temperature Range	Package
IMP5218CDW	0°C to 125°C	16-pin Plastic SOWB
IMP5218CDWT	0°C to 125°C	Tape and Reel, 16-pin Plastic SOWB
IMP5218CPW	0°C to 125°C	20-pin Plastic TSSOP
IMP5218CPWT	0°C to 125°C	Tape and Reel, 20-pin Plastic TSSOP

5218\_t01.at3

# Absolute Maximum Ratings<sup>1</sup>

Note: 1. Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal.

#### Thermal Data

DW Package:

Thermal Resistance Junction-to-Ambient,  $\theta_{JA}$  . . . . . . 95°C/W PW Package:

Thermal Resistance Junction-to-Ambient,  $\theta_{JA}$  ..... 144°C/W

Junction Temperature Calculation:  $T_J = T_A + (P_D x \theta_{JA})$ .

The  $\theta_{JA}$  numbers are guidelines for the thermal performance of the device/pc-board system. All of the ambient airflow is assumed.



# Recommended Operating Conditions<sup>2</sup>

Parameter	Symbol	Min	Тур	Max	Units
Termpwr Voltage	$V_{TERM}$	3.5		5.5	V
High Level Disable Input Voltage	V <sub>IH</sub>	2		$V_{TERM}$	V
Low Level Disable Input Voltage	V <sub>IL</sub>	0		0.8	V
Operating Junction Temperature Range		0		125	°C

Note: 2. Recommended operating conditions indicate the range over which the device is functional.

5218\_t02.eps

### **Electrical Characteristics**

Unless otherwise specified, these specifications apply at an ambient operating temperature of  $T_A = 25$ °C. TermPwr = 4.75V. Low duty cycle pulse testing techniques are used which maintain junction and case temperatures equal to the ambient temperature.

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Output High Voltage	V <sub>OUT</sub>		2.65	2.85		V
TermPwr Supply Current	I <sub>CC</sub>	All data lines = Open		6	9	mA
		All data lines = 0.5V		215	225	mA
		DISCONNECT Pins 1, 2 = 0V		375		μΑ
Output Current	I <sub>OUT</sub>	V <sub>OUT</sub> = 0.5V	-21	-23	-24	mA
Disable Input Current	I <sub>IN</sub>	DISCONNECT Pins 1, 2 = 4.75V		90		μΑ
		DISCONNECT Pins 1, 2 = 0V		-10		μΑ
Output Leakage Current	I <sub>OL</sub>	DISCONNECT Pins = 0V, V <sub>O</sub> = 0.5V		10		nA
Capacitance in Disabled Mode	C <sub>OUT</sub>	V <sub>OUT</sub> = 0V, Frequency = 1MHz		3		pF
Channel Bandwidth	BW			35		MHz
Termination Sink Current, per Channel	I <sub>SINK</sub>	V <sub>OUT</sub> = 4V		60		mA

5218\_t03.eps

© 2000 IMP, Inc. Data Communications 3



### **Application Information**

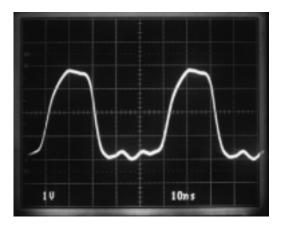


Figure 1. Receiving Waveform - 20MHz

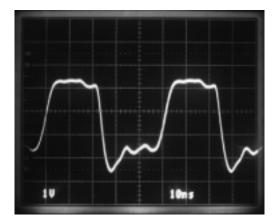


Figure 2. Driving Waveform - 20MHz

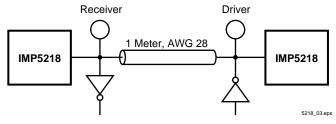


Figure 3.

#### **IMP5218 Maximizes Line Current**

Cable transmission theory suggests to optimize signal speed and quality, the termination should act both as an ideal voltage reference when the line is released (deasserted) and as an ideal current source when the line is active (asserted). Common active terminators which consist of linear regulators in series with resistors (typically  $110\Omega$ ) are a compromise. With coventional linear terminators as the line voltage increases the amount of current decreases linearly by the equation;

$$\frac{\left(V_{REF}-V_{LINE}\right)}{R}=I.$$

The IMP5218, with its unique new architecture, applies the maximum amount of current regardless of line voltage until the termination high threshold (2.85V) is reached.

Acting as a near ideal line terminator, the IMP5218 closely reproduces the optimum case when the device is enabled. To enable the

device the Disconnect 1 and Disconnect 2 pins must be driven per *Table 1*. When enabled, quiescent current is 6mA and the device will respond to line demands by delivering 24mA on assertion and by imposing 2.85V on de-assertion.

#### Disable/Sleep Mode

Disable/Sleep mode can be used for power conservation or to remove the terminator from the SCSI chain.

The IMP5218 is disabled when both disconnect pins are driven logic LOW.

Disable mode places the device in a sleep state, where quiescent current is typically  $375\mu A$ . When disabled, all outputs are in a high impedance state and each output has only 3pF of capacitance.

An additional feature of the IMP5218 is its compatibility with active negation drivers.



# **Application Information**

**Table 1. Power Up/ Power Down Function Table** 

DISCONNECT 1	DISCONNECT 2	Outputs	Quiescent Current
Н	Н	Enabled	6mA
Н	L	Enabled	6mA
L	Н	Enabled	6mA
L	L	Disabled/High Impedance	375μΑ
Open	Open	Enabled	6mA

5218\_t04.eps

# Typical Characteristics

Figure 4. Receiving Waveform

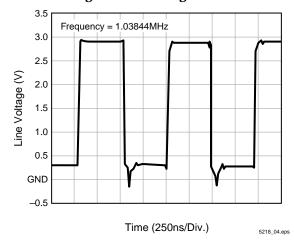
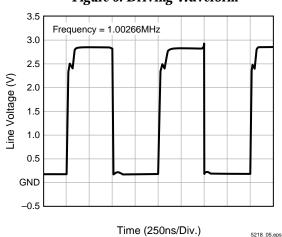


Figure 5. Driving Waveform



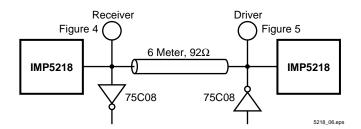


Figure 6. End-Driven Cable

© 2000 IMP, Inc. Data Communications 5



Figure 7. Receiving Waveform

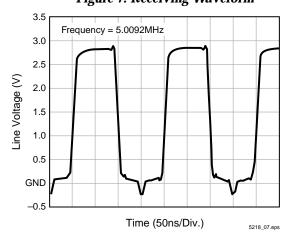
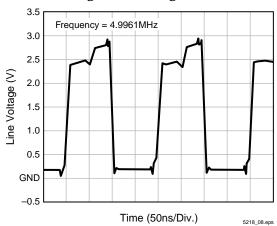


Figure 8. Driving Waveform



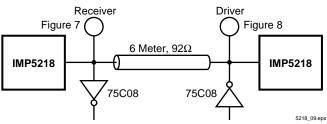


Figure 9. End-Driven Cable

Figure 10. 10MHz Waveform

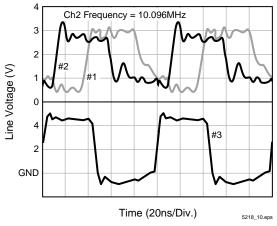
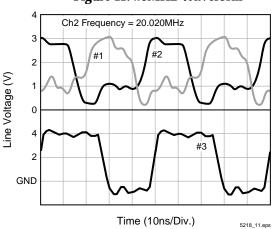


Figure 11. 20MHz Waveform



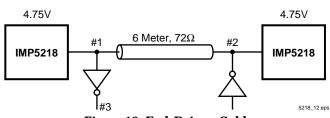


Figure 12. End-Driven Cable





Figure 13. Output High Voltage vs. Junction Temperature

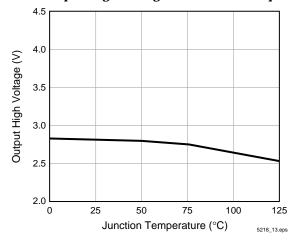


Figure 14. Output Current vs. Junction Temperature

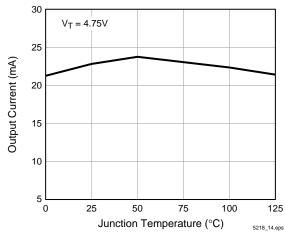


Figure 15. Output Current vs. Output High Voltage

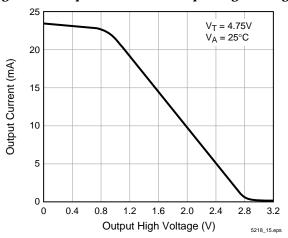


Figure 16. Output Current vs. Output High Voltage

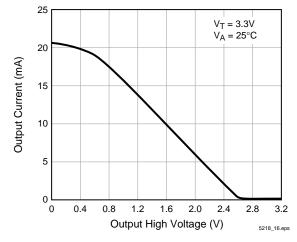


Figure 17. TermPwr Supply Current vs. Termination Voltage

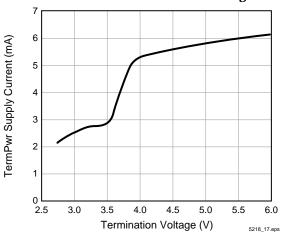


Figure 18. TermPwr Supply Current vs. Termination Voltage (Disabled)

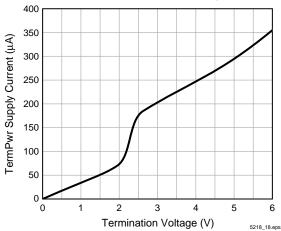




Figure 19. Output High Voltage vs. Junction Temperature

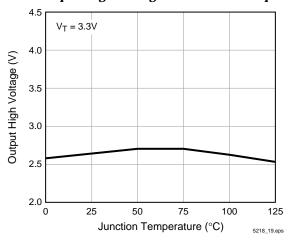


Figure 21. Output High Voltage vs. Termination Voltage

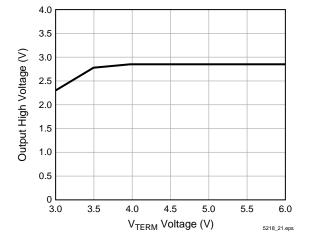


Figure 20. Output Current vs. Junction Temperature

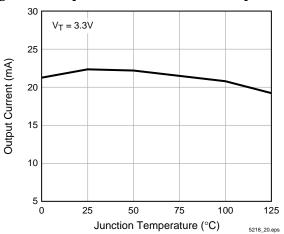
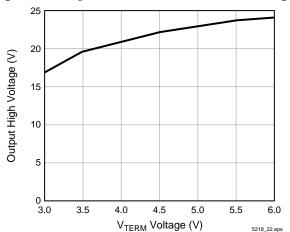


Figure 22. Output Current vs. Termination Voltage





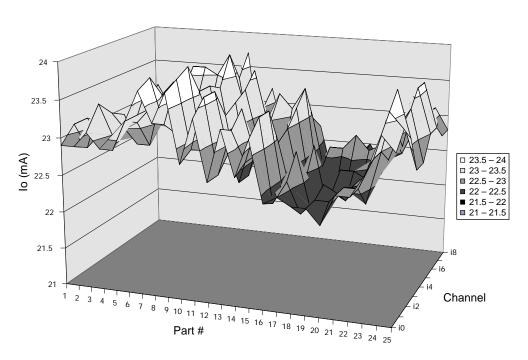


Figure 23. Output Current Matching Channel to Channel

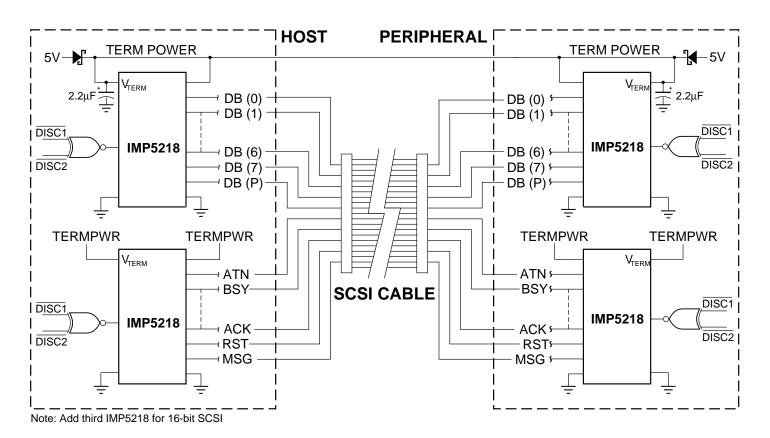


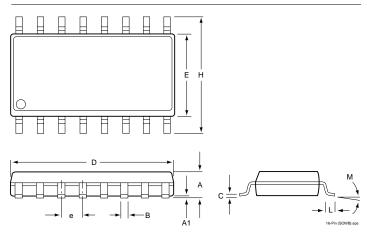
Figure 24. 8-Bit SCSI System Application



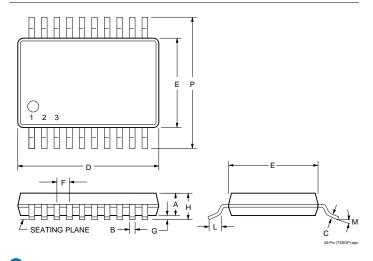


# Package Dimensions

#### SOWB (16-Pin)



#### TSSOP (20-Pin)



Inches			Millimeters			
	Min	Max	Min	Max		
SOWB (16-Pin)						
Α	0.093	0.104	2.35	2.65		
A1	0.004	0.012	0.10	0.30		
В	0.013	0.020	0.33	0.51		
С	0.009	0.013	0.23	0.32		
D	0.398	0.413	10.10	10.50		
Е	0.291	0.299	7.40	7.60		
е	0.05	BSC	1.27 BSC			
Н	0.394	0.419	10.00	10.65		
L	0.016	0.050	0.40	1.27		
М	0°	8°	0°	8°		
*LC	_	0.004	_	0.10		
		TSSOP (20	0-Pin)			
Α	0.033	0.037	_	0.90		
В	0.007	0.012	0.18	0.30		
С	0.0035	0.008	0.90	0.180		
D	0.252	0.260	6.40	6.60		
Е	0.169	0.177	4.30	4.48		
F	0.025	BSC	0.65 BSC			
G	0.002	0.005	0.05	0.15		
Н		0.0433	_	1.10		
L	0.020	0.028	0.50	0.70		
М	0°	8°	0°	8°		
Р	0.246	0.256	6.25	6.50		
*LC	_	0.004	_	0.10		

\* Lead Coplanarity

5218\_t06.at3



IMP, Inc.

Corporate Headquarters 2830 N. First Street San Jose, CA 95134-2071

Tel: 408-432-9100

Fax: 408-432-9100

e-mail: info@impinc.com http://www.impweb.com